

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

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Division of Serial No. 10/633,434 Art Unit:
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Filing Date: 03/10/2004 Examiner:

For: Method For Fabricating Semiconductor
Component With Chip On Board Leadframe
(As Amended)

Attorney Docket No. 02-1467.1

**PRELIMINARY AMENDMENT
SUBMITTED WITH CONTINUING APPLICATION
UNDER 37 CFR 1.53(b)**

March 10, 2004

Mail Stop Patent Application
Commissioner of Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

This Preliminary Amendment is being filed with a
divisional continuing application under 37 CFR 1.53(b).
Please amend the case as follows.